



Patent

Customer No. 31561  
Attorney Docket No. 9223-US-PA  
Application No.: 10/064,644

I Fw

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Instant application of

Applicant : Hsu  
Application No. : 10/064,644  
Filed : 2002/08/02  
For : FLIP-CHIP DIE FOR JOINING WITH A FLIP-CHIP  
SUBSTRATE  
Patent No. : 6,710,459 B2  
Issue date : 2004/3/23

**REQUEST FOR OBTAINING PATENT GRANT**

**VIA COURIER**  
(Total pages: 2)

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Dear Sir:

It is indicated in the Patent Application Information Retrieval (PAIR) that the patent grant for the above-identified patent has been mailed to Applicant on the date of April 1, 2004. A printout of the message shown in the PAIR is attached herewith for reference. However, so far the same has not yet been received.

Applicant hereby requests your authority to verify the postal status of the said patent grant. If the status is such that the said patent grant is lost in the postal service, please re-arrange to forward the same to Applicant at your earliest convenience.

I believe that no fee is incurred by this request as the safe delivery of the said patent grant is entirely not Applicant's responsibility. However, the Commissioner is authorized to charge any fee required in connection with this request to Deposit Account No. 50-2620 (Order No.: 9223-US-PA).

Patent

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A prepaid return postcard is enclosed.

Thank you for your assistance in the subject matter. If you have any questions, please feel free to contact the undersigned.

Respectfully Submitted,  
JIANQ CHYUN Intellectual Property Office

Date: Nov. 19, 2004

By: Belinda Lee  
Belinda Lee  
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**: 10/064,644**

## FLIP-CHIP PACKAGE SUBSTRATE AND FLIP CHIP DIE

Application Data	Transaction History	Image File Wrapper	Patent Term Adjustments	Foreign Priority	Published Documents	F
	Date	Contents Description				
	04-01-2004	Recordation of Patent Grant Mailed				
	03-04-2004	Issue Notification Mailed				
	03-23-2004	Patent Issue Date Used in PTA Calculation				
	02-20-2004	Receipt into Pubs				
	02-16-2004	Application Is Considered Ready for Issuance				
	02-05-2004	Workflow - Drawings Finished				
	02-05-2004	Mailroom Date of Issue Fee Payment				
	02-09-2004	Receipt into Pubs				
	02-05-2004	Issue Fee Payment Recorded				
	01-06-2004	Workflow - File Sent to Contractor				
	12-12-2003	Mail Notice of Allowance				
	12-12-2003	Mail Formal Drawings Required				
	12-11-2003	Formal Drawings Required				
	12-11-2003	Notice of Allowance Data Verification Complete				
	12-11-2003	Notice of Allowability				
	11-17-2003	IFW Amended case processing Completed				
	10-29-2003	Date Forwarded to Examiner				
	10-20-2003	Response after Non-Final Action				
	07-30-2003	Mail Non-Final Rejection				
	07-24-2003	Non-Final Rejection				
	05-20-2003	Date Forwarded to Examiner				
	05-15-2003	Response to Election / Restriction Filed				
	04-15-2003	Mail Restriction Requirement				
	04-14-2003	Requirement for Restriction / Election				
	09-05-2002	Request for Foreign Priority (Priority Paid)				
	08-27-2002	Case Docketed to Examiner in GAU				
	08-22-2002	Case Docketed to Examiner in GAU				
	08-13-2002	Application Dispatched from OIPE				